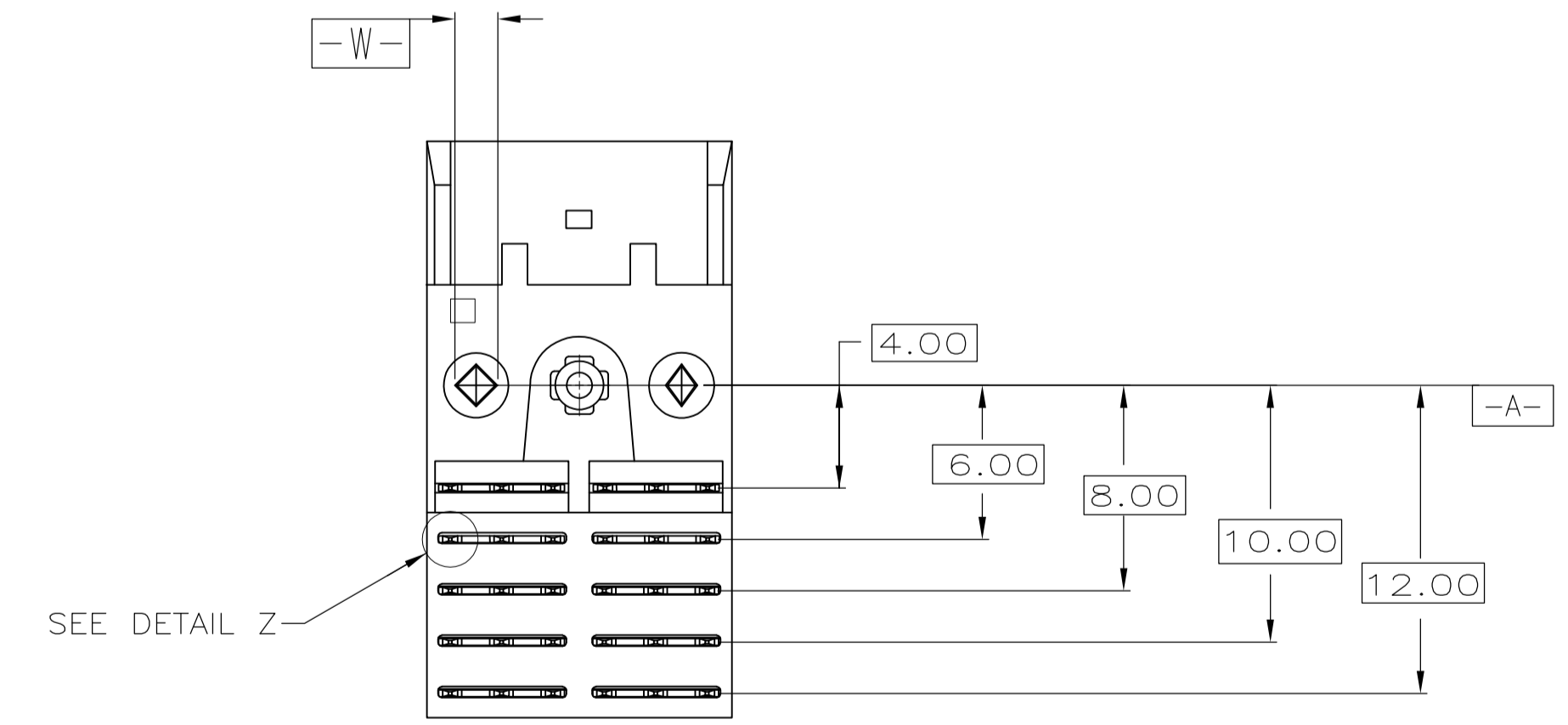
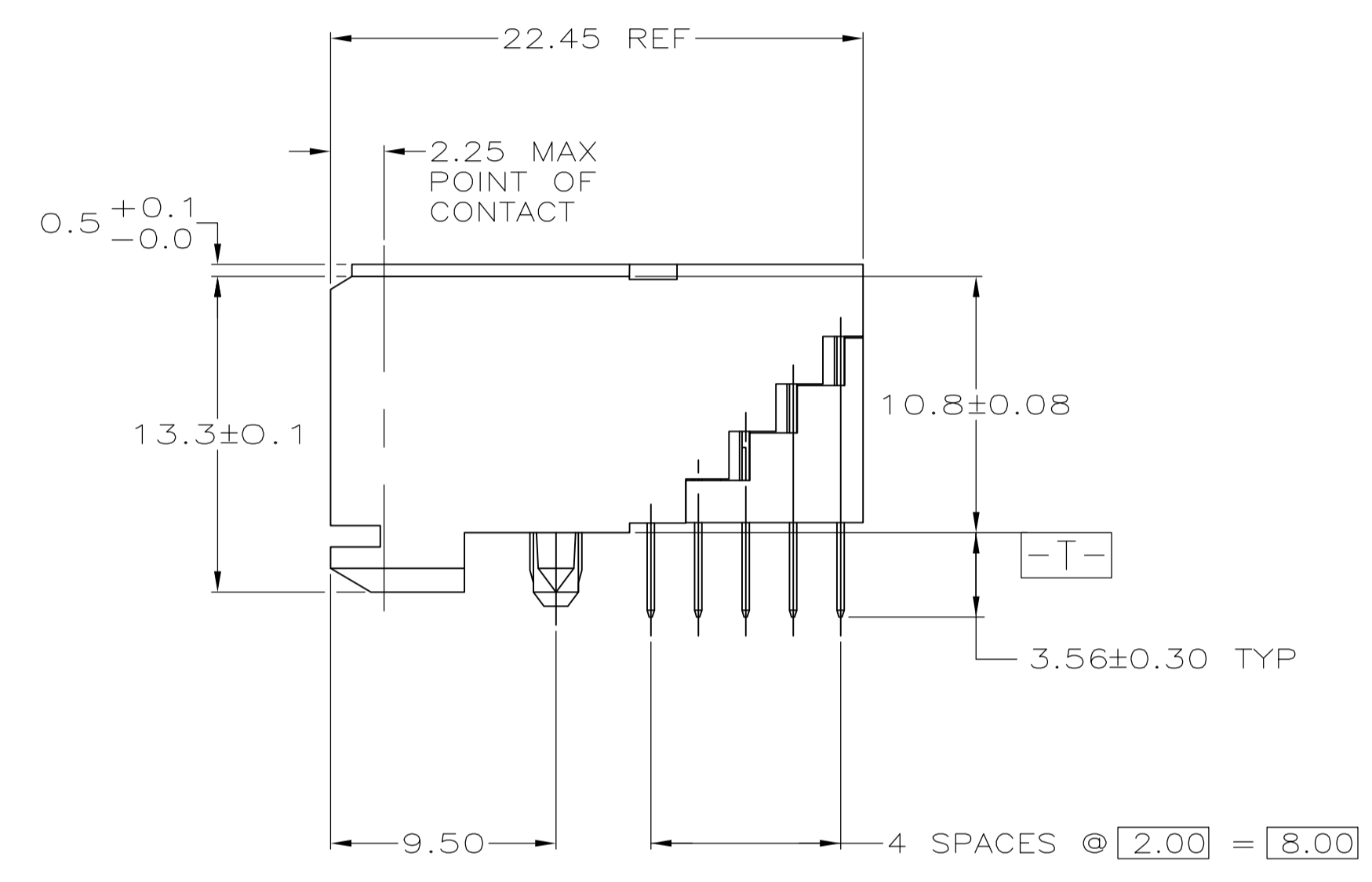
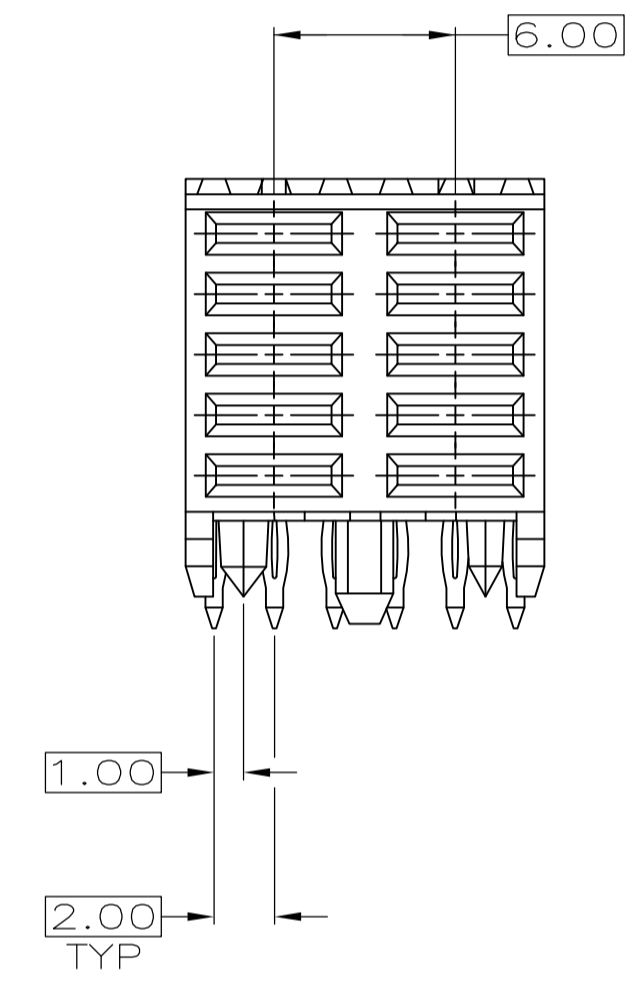
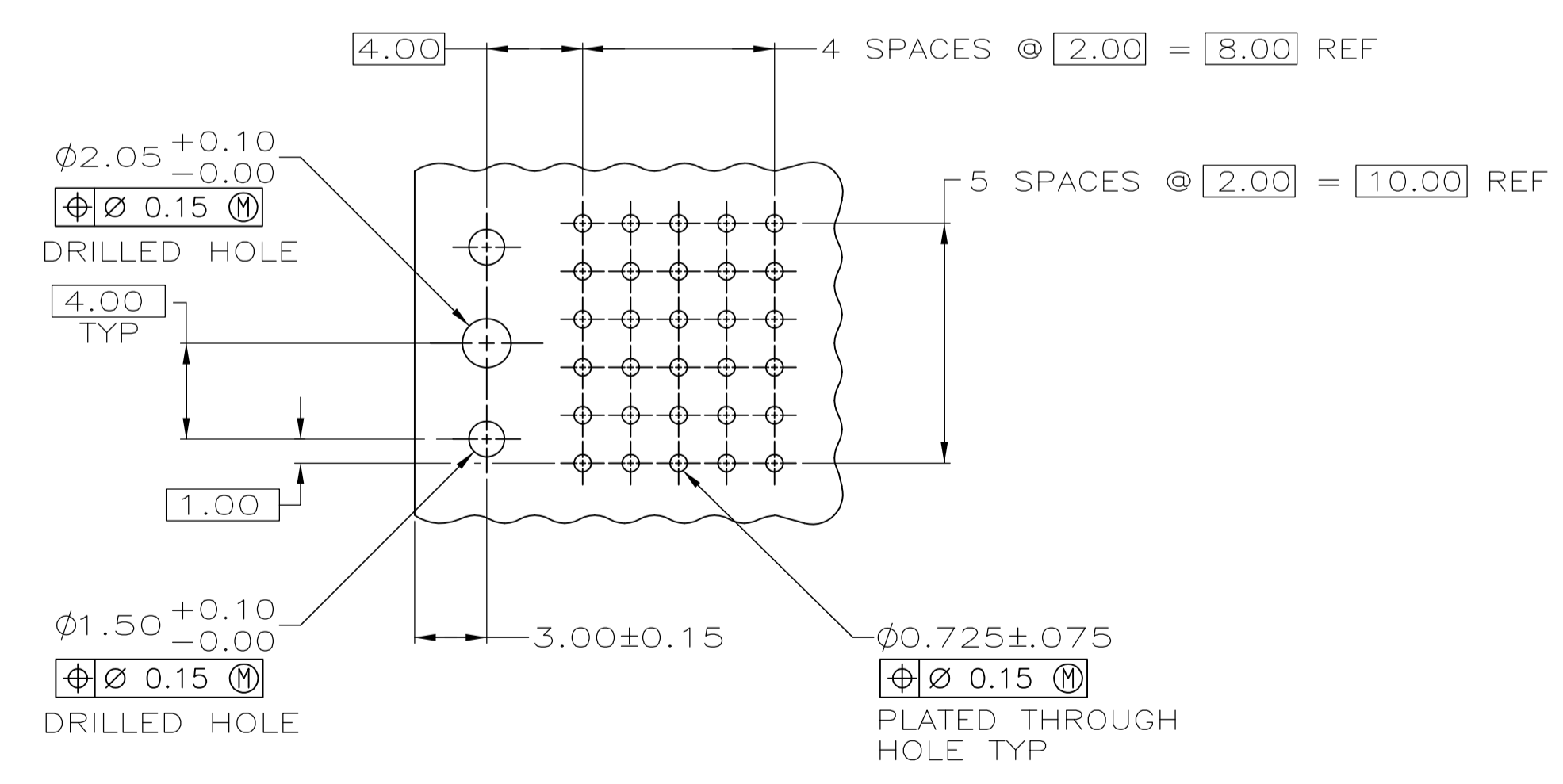


DETAIL Z
SCALE 20:1

- ① HOUSINGS MATERIAL: LIQUID CRYSTAL POLYMER.
- ② CONTACT MATERIAL: COPPER ALLOY
- ③ CONTACT FINISH:
 UNDERPLATE (ENTIRE CONTACT):
 0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290
 ON MATING SURFACES:
 FLASH GOLD PER ASTM B 488, OVER
 0.00076 MIN PALLADIUM-NICKEL OVER UNDERPLATE, OR
 0.00076 MIN GOLD PER ASTM B 488 OVER UNDERPLATE.
 ON LEADS:
 0.00127 MIN TIN-LEAD OVER UNDERPLATE.
 LUBRICATION (MIN MATING SURFACES):
 SURFACE CONDITIONER AFTER PLATING.



SEE DETAIL Z



RECOMMENDED CURCUIT PATTERN
 PER IPC-D300 TYPE II, CLASS C
 (COMPONENT SIDE)

③	536676-1
FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN	5-29-98	Tyco Electronics Corporation Harrisburg, PA 17105-3608 R/A,5 ROW,10 POSN,W/TAIL ORGANIZER PRODUCT SPEC
DIMENSIONS: mm		CHK	6-22-98	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD	6-22-98	
0 PLC ± - 1 PLC ± - 2 PLC ± 0.13 3 PLC ± - 4 PLC ± - ANGLES ± -		NAME		
MATERIAL		FINISH		WEIGHT CUSTOMER DRAWING
① ② ③		A1 00779 C=536676		SCALE: 4:1 SHEET: 1 OF 1 REV: J1

OBsolete
NOT the LATEST REVISION